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H8/300L SLP Series

Emulating SCI using I/O Port (portSCI)

Introduction

Multi-channel communications with various external devices may be required in some applications. A simple means of communication is to use the serial port. However, due to the limited serial ports available, there may be a need to implement the communication using I/O port.

In this document, an asynchronous communication channel using two I/O lines is implemented. The transmission and reception links have been established with the PC at 9600 bps.

Target Device

H8/38024

Contents

1. Theory ........................................................................................................................................ 2
2. Operation ...................................................................................................................................... 6
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1. Theory

1.1 Overview

The software for simulated serial communication interface is written in C for easy portability. The H8/38024 microcontroller is used as the target in this application note.

The UART protocol used for this application note is 1 start bit, 8 data bits, no parity bit, and 1 stop bit as shown below.

<table>
<thead>
<tr>
<th>D0</th>
<th>D1</th>
<th>D2</th>
<th>D3</th>
<th>D4</th>
<th>D5</th>
<th>D6</th>
<th>D7</th>
</tr>
</thead>
<tbody>
<tr>
<td>Start Bit</td>
<td>8 Data Bits</td>
<td>Stop Bit</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

![Figure 1 UART Protocol](image)

In order to transmit and receive data correctly, the bit period must be accurate. Slight variations would result in accumulation of timing errors and hence data will be decoded wrongly. The bit period is calculated as follows:

\[
\text{Bit period} = \frac{1}{\text{baud rate}}
\]

As for the baud rate of 9600 bps, the bit period would be:

\[
\text{Bit period} = \frac{1}{9600} = 104.167 \mu s
\]

In order to generate this bit period, either a timer function or a *for loop* could be used. An accurate value has to be used for the timer register value or the *for loop*.

For transmission, the output port pin is pulled high. A ‘0’ is sent for the start bit followed by 8 data bits, in which the least significant bit (D0) is sent first, and finally a ‘1’ is sent for the stop bit.

The receiving port pin also has to be pulled high. When the signal level goes low, either a start bit is received or unwanted noise causes a drop in voltage level. Hence, a delay of half a bit period is carried out before sampling to verify a ‘0’ for the start bit.
1.2 Implementation

The 38024F CPU board is used in this application note. Pin 6 of Port 1 (P16) is used as the transmit channel and pin 4 of Port 1 (P14) is used to receive the external serial data. The crystal frequency used is 9.8304 MHz and the baud rate is 9600bps. These can be easily changed to the user’s requirement in the C program.

For transmission, P16 is configured as an output with its MOS pulled high. The data is transmitted by calling the transmit subroutine.

P14 is configured as an input with its MOS also pulled high. This I/O pin is multiplexed with the IRQ4 activation.

Before receiving any data, P14 is set to accept an external interrupt. IRQ4 interrupt is initialized for high-to-low edge triggering, hence the high-to-low transition at the line after receiving the start bit would generate an interrupt to start the IRQ4 interrupt service routine to perform the receive operation.

In the interrupt service routine, P14 is set to function as an input port pin to receive the data stream. The software waits for half a bit period as soon as the IRQ4 interrupt occurs to sample the start bit. After detecting the start bit, the receive subroutine waits for a bit period to sample each of the 8 data bits. This process is illustrated in figure 2.

![Figure 2 Sampling Periods](image)

Timer F is used to implement the delay for the bit period. Timer F is initialized as a 16-bit timer and generates an interrupt when a compare match occurs. The calculation for the output compare register value is shown in the following section 1.3.
1.3 Output Compare Register Value Calculation

Timer F is a free running counter with a built-in output compare function. It is initialized to generate an interrupt when a compare match occurs. That is, Timer Control Register F (TCRF) starts incrementing and an interrupt is generated once its value matches that of the value in Output Compare Register FH (OCRFH).

The internal clock is set to $\phi/4$, by setting bits 2 to 1 of Timer Control Register F (TCRF) as indicated in bold in table 1.

<table>
<thead>
<tr>
<th>Bit 2 CKSL2</th>
<th>Bit 1 CKSL1</th>
<th>Bit 0 CKSL0</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>Counting on external event (TMIF) rising/falling edge</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>Use prohibited</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>Internal clock: counting on $\phi/32$</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>Internal clock: counting on $\phi/16$</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>0</td>
<td>Internal clock: counting on $\phi/4$</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>1</td>
<td>Internal clock: counting on $\phi/4$</td>
</tr>
</tbody>
</table>

The output compare register value is calculated as follows:

For: Bit period = 1/baud rate

$\phi =$ crystal frequency/2

Internal clock = $\phi/4$

d = output compare register value

Therefore: $d \times$ internal clock period = bit period required

$$d \times \frac{1}{\text{crystal frequency}} = \frac{1}{2 \times 4} \times \frac{1}{\text{bit period}}$$

$$d = \frac{\text{crystal frequency}}{8 \times \text{baud rate}}$$

However, Timer F needs a time of around 25µs before it is initialized and starts incrementing its 16-bit timer counter TCF. This would result in a longer bit period, hence the value needs to be offset. It is found that the offset of 49 is required in this application note when the crystal oscillator (9.3204 MHz) is used.

Therefore, the value to be loaded into OCRFH is $d - 49$.

Note: This delay of Timer F for initialization depends on the value of crystal oscillator used. User has to change the offset value if a different crystal oscillator is used.
1.4 Alternative Solution

- Polling for start bit
  Instead of using an interrupt to detect the start bit, the user can use a polling method. The user can continuously read the receive pin, P14, to wait for the start bit. An example code is shown below.

```c
while(1)
{
  if (RX == 0)
    receive();
}
```

However, this method could only be used when the main program has nothing else to perform as the user needs to continuously check the receive pin.

- Using `for loop` for delay
  A `for loop` can be used in place of Timer F to implement the delay required for the bit period. The user would be required to find out the suitable delay value for the `for loop`. An example for such a delay subroutine is shown as follows.

```c
void delay (unsigned short d)
{
  for (i = 0; i < d; i ++)
}
```
2. Operation

2.1 Hardware Setup

In order to communicate with an external device, the RS-232 connection has to be setup. A simple serial driver has to be built to condition the signal level between the MCU and external target device. The I/O pins have to be pulled high via 10-K pull-up resistors.

A schematic diagram for the RS-232C driver is given in figure 4.
2.2 Hyper Terminal Setting

When the user sets up communication between the MCU and PC using HyperTerminal, the COM port settings have to be made in accordance with the UART protocol and baud rate used in the program.

For the baud rate of 9600 bps, the following settings have to be made to the COM port connected to the RS-232C driver. Select Properties in the File menu of HyperTerminal window and click on Configure… to change the Port Settings.

Next, setup the HyperTerminal so that the character keyed in by the user will be shown in the HyperTerminal window. Click on ASCII Setup… in the Settings tab and click in the check box of Echo typed characters locally as shown in figure 6.
By setting the correct baud rate, the user will be able to see the characters **Test** displayed in the HyperTerminal. The user can enter any characters in the Hyper Terminal and the decoded character will be re-transmitted onto the hyper terminal window for verification. Figure 7 shows an example of the result on the Hyper Terminal window. If the character is decoded wrongly (when the stop bit is not detected), **Er** is transmitted and will be displayed on the Hyper Terminal window.
3. Code Listing

The following attached code for this application note is generated using the HEW project generator targeting at the H8/38024 MCU. The tool chain used is the SLP/TINY tool chain.

Flowcharts are included to illustrate the main functionality and to give a better understanding for user.

Note: Optimization must be turned off for the program to work.
```c
#include <machine.h>
#include <_h_c_lib.h>

#include "iodefine.h"
#include "flagdefine.h"

void initialize (void);
void transmit (unsigned char);
void receive (void);
void transmit_string (void);
void delay (unsigned short);
char *buff_ptr;
static const char TX_buffer[] = "Test";  // Transmit buffer
char RX_buffer;       // Receive buffer
unsigned int i =0;

int main(void)
{
    initialize();
    transmit_string();
    while(1);
}

void initialize (void)
{
    // Initialize Port 1
    P_IO.PUCR1.BIT.PUCR16 = 1; // P16 MOS pull-up
    TX = 1;
    P_IO.PCR1.BIT.PCR16 = 1;  // P16 as output (TX)

    // Initialize IRQ4
    P_SYSCR.IEGR.BIT.IEG4 = 0; // Interrupt generated at falling edge of
                               // IRQ4
    P_SYSCR.IENR1.BIT.IEN4 = 1; // Enables IRQ4
    P_IO.PMR1.BIT.IRQ4 = 1;  // P14 used as IRQ4
}
```
// Initialize Timer F
P_TMRF.TCRF.BYTE = 0x8E; // Set TMOFH pin output level to HIGH and
// internal clock of o/4
P_TMRF.TCSRFB.BIT.CCLRH = 1; // TCF cleared when TCF and OCRF match

//--------------- Transmit a character ----------------//

void transmit (unsigned char a) {
    int i;
    MON_RAM.TX_CHAR.BYTE = a;

    // start bit
    TX = 0;
    delay(bit_period);

    // 8 data bits
    for (i=0; i<8; i++) {
        if (MON_RAM.TX_CHAR.BIT.bit0 == 0)
            TX = 0;
        else
            TX = 1;

        delay(bit_period);
        MON_RAM.TX_CHAR.BYTE = MON_RAM.TX_CHAR.BYTE >> 1;
    }

    // stop bit
    TX = 1;
    delay(bit_period);
}

//--------------- Transmit characters in Transmit Buffer ----------------//
void transmit_string (void)
{
    buff_ptr = (char *)&TX_buffer;

    while ( *buff_ptr != 0)
    {
        MON_RAM.TX_CHAR.BYTE = (*buff_ptr++);
        transmit(MON_RAM.TX_CHAR.BYTE); // call transmit subroutine to transmit
        // each character
    }
}

//--------------- Store characters in RX_CHAR ------------------
void receive (void)
{
    int j;
RX_buffer = 0;

// Receive data bits
for (j=0; j<8; j++)
{
    delay(bit_period);
    if (RX == 1)
        MON_RAM.RX_CHAR.BYTE = MON_RAM.RX_CHAR.BYTE | (0x01 << j);
    else
        MON_RAM.RX_CHAR.BYTE = MON_RAM.RX_CHAR.BYTE & rotlc(j,0xFE);
}

// Receive stop bit
delay(bit_period);
if (RX != 1)
{
    transmit('E');   // error if sampled stop bit='0', transmit 'Er'
    transmit('r');
} else
{
    RX_buffer = MON_RAM.RX_CHAR.BYTE ; // save character in receive
                                      //buffer
    transmit(RX_buffer);              // transmit character in receive
                                      //buffer
}
P_IO.PMR1.BIT.IRQ4 = 1;   // P14 used as IRQ4

//--------------- Delay function using Timer F ----------------//
void delay (unsigned short d)
{
    d = d-49;    // decrease d to offset for delay during setup of timer
    P_TMRF.OCR1.BYTE.H = d<<8;   // save count (d) in output compare register
    P_TMRF.OCR1.BYTE.L = d;
    P_TMRF.TCSR.BIT.CMFH = 0;   // Clear compare match flag
    P_TMRF.TCF.BYTE.H = 0;      // Clear counter and start the timer F
    P_TMRF.TCF.BYTE.L = 0;
    while (P_TMRF.TCSR.BIT.CMFH == 0);  // Loop until a compare match occurs
    P_TMRF.TCSR.BIT.CMFH = 0;  // Clear compare match flag
Figure 8 Main Program

Main

Initialize Routine

Store characters to be transmitted in TX_buffer

Initialize Port 1

Initialize IRQ4

Initialize Timer F

Transmit String Routine

Wait loop
Figure 9  Transmit Routine

- Transmit
- TX = 0
  - Delay for 1 bit period
  - Check bit 0
    - MON_RAM.TX_CHAR = 0 → TX = 0
    - MON_RAM.TX_CHAR = 1 → TX = 1
  - Delay for 1 bit period
  - Right Shift
    - MON_RAM.TX_CHAR by 1 bit
    - i < 8
      - No
      - Yes
        - TX = 1
        - Delay for 1 bit period
        - END
Figure 10   Receive Routine

Receive

Delay for 1 bit period

= 0  
Check RX  = 1

MON_RAM.RX_CHAR  
AND with H'FE and  
Left Shift by 1 bit

MON_RAM.RX_CHAR  
OR with H'01 and  
Left Shift by 1 bit

i < 8

No  
Yes

Delay for 1 bit period

Transmit ‘Er’ to indicate error

RX = 1

No  
Yes

Transmit decoded character

Set P14 as IRQ4

END
#define XTAL  9830400L  // for crystal frequency of 9.83204Mhz
#define BAUD  9600L   // for baud rate of 9600
#define bit_period (XTAL / (8*BAUD)) // for internal clk = Ø /4
     // NOTE: Ø = XTAL/2
#define sample  ((bit_period) / 2L)
#define TX    P_IO.PDR1.BIT.P16 // Port 1 pin 6 as transmit pin
#define RX    P_IO.PDR1.BIT.P14 // Port 1 pin 4 as receive pin
NOTE: Add the following in the IRQ4 vector

```c
void INT_IRQ4(void)
{
    set_imask_ccr(1); // Disable interrupts
    P_IO.PMR1.BIT.IRQ4 = 0; // P14 used as i/o pin
    P_IO.PCR1.BIT.PCR14 = 0; // P14 as Input (RX)
    P_IO.PUCR1.BIT.PUCR14 = 1; // P14 MOS pull-up

    delay(sample); // delay half a bit period to sample at the middle
                    // of each bit
    if (RX == 0) // Start receive sequence if sampled start bit equals '0'
        receive();
    P_SYSCR.IRR1.BIT.IRRI4 = 0; // clear interrupt request flag
}
```
Figure 11  Interrupt Service Routine 4 (IRQ4)
## Revision Record

<table>
<thead>
<tr>
<th>Rev.</th>
<th>Date</th>
<th>Description</th>
</tr>
</thead>
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<tr>
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